

[Provisional Translation Only]

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JDI Wins Japan Industrial Packaging Award

JDI has jointly received an Industrial Packaging Award in the Japan Packaging Contest 2026 organized by the Japan Packaging Institute (JPI). The award recognizes JDI's collaborative effort with SBS Toshiba Logistics Corporation and Nihon Houzai Co., Ltd. in developing packaging specifications for thin glass panels and their joint contribution to reducing environmental impact and improving logistics efficiency.

1. Award Highlights

Previously, multiple, different trays were required for transportation, storage, and production processes involving thin glass panels, resulting in frequent tray replacement and the use of a large number of trays. The award-winning packaging specifications address these challenges by replacing three types of packaging materials with one standardized design. This reduced the total number of trays to approximately one-third of the previous level and eliminated the need to replace trays between processes, significantly improving operational efficiency. The main features are as follows.

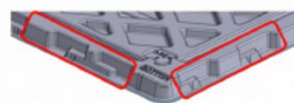
2. Common Tray Design Concept

(1) Reverse-Stacking Structure

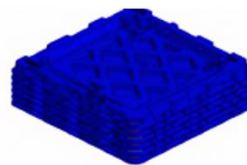
The common tray adopts a stackable structure that allows trays to be stacked after being rotated 180 degrees horizontally. This design enables stacking using a single tray type without requiring dedicated lids. As a result, simplified packaging has improved operational efficiency and reduced workload at manufacturing sites.

Transportation Between Domestic Production Processes

Reversible stacking structure enabling stackability with a common tray only



Reversible Stacking



Tray-Only Stacking

(2) Deep Pocket Structure

To accommodate increases in product thickness caused by the addition or attachment of components during manufacturing processes, the tray incorporates a deep pocket structure. This enables the transportation tray to be used directly within customers' production processes, eliminating the need for tray replacement and improving operational efficiency while reducing environmental impact.

Customer Manufacturing Process

Deep Pocket Design Accommodates Changes in Product Thickness



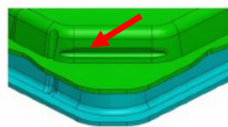
Tray Cross Section

(3) Corner Lock Mechanism and Diamond-Shaped Structure

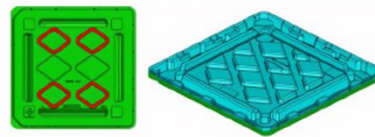
To prevent lids from coming loose due to impacts during long-distance transportation and to ensure stable stacking during storage, the design incorporates a corner-lock mechanism that secures adjacent lids. In addition, a diamond-shaped structure at the engagement area between the lid and tray enhances overall strength and durability.

Export and Storage

- Locking mechanism between dedicated export/storage lids helps prevent cargo collapse during transportation
- Diamond-shaped tray-to-lid fitting structure improves strength



Locking Structure



Export/Storage Lid & Diamond-Shaped Tray Bottom

3. Benefits of the Common Tray

The introduction of the common tray has reduced the number of tray types previously required at different process stages, lowering the consumption of packaging materials and eliminating tray replacement work between processes. These improvements have reduced workloads across logistics, storage, and manufacturing operations and enhanced efficiency throughout the supply chain.

JDI will continue collaborating with partner companies to address challenges at logistics and manufacturing sites. JDI also remains committed to developing packaging technologies and logistics solutions that reduce environmental impact, improve logistics quality, and increase efficiency across the entire supply chain, contributing to the realization of a sustainable society.

About the Japan Packaging Contest

Organized by the Japan Packaging Institute (JPI), the Japan Packaging Contest is one of Japan's leading competitions for packaging technology and design. Entries are evaluated from a broad range of perspectives, including packaging materials, structural design, protective performance, environmental considerations, design, transport packaging, and logistics. Award-winning entries may use the Good Packaging (GP) Mark and are eligible to enter the WorldStar Awards organized by the World Packaging Organisation (WPO). The contest helps showcase Japanese packaging technology in Japan and internationally.